AF Control LSI

LC898249XH

Overview

This LSI is Closed–Auto Focus control LSI equipped with hall sensor. It consists of 1 system of feedback circuit and constant current driver. It has also a built–in EEPROM and temperature sensor.

Features

- Built-in Equalizer Circuit Using Digital Operation
 - AF Control Equalizer Circuit
 - Any Coefficient can be Specified by 2-wire Serial I/F (TWIF)
- 2-wire Serial Interface
 - (The Communication Protocol is Compatible with I²C)
 - 4 Selectable Slave Addresses
 - -50h(W)/51h(R), 53h(R)
 - 74h(W)/75h(R), 77h(R)
 - E8h(W)/E9h(R), EBh(R)
 - E4h(W)/E5h(R), E7h(R) factory-configured
 - Right Side Addresses are Used at the Access of Built-in EEPROM
- Built-in A/D Converter
- Built-in D/A Converter
 - Hall Offset
 - Constant Current Bias
- Built-in Hall Sensor
 - Si Hall Sensor
- Built-in EEPROM
 - ◆ 64 Byte (16 Byte / Page)
- Built-in OSC
- Built-in Constant Current Driver
 - ◆ 150 mA
- Package
 - WLCSP 6-pin (2 x 3 Pin), Thickness Max 0.29 mm, with Backside Coat
- Supply Voltage
 - VDD (2.6 V to 3.3 V)
- This Device is Pb–Free, Halogen Free/BFR Free and is RoHS Compliant



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WLCSP6, 0.86x1.75x0.265 CASE 567XD

MARKING DIAGRAM

	0	8249XH ALYWW	
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8249XH = Specific Device Code

- = Assembly Location
- = Wafer Lot
- = Year

А

L

Υ

WW = Work Week

ORDERING INFORMATION

Device	Package	Shipping [†]
LC898249XHTBG	WLCSP6	4000 / Tape & Reel

+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

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PIN DESCRIPTION

Table 1. PIN DESCRIPTION

Pin Name	Description
I	Input
Р	Power Supply, GND
NC	Not Connect
0	Output
В	Bidirection

• 2-wire serial interface

SCL	Ι	2-wire serial interface clock pin
SDA	В	2-wire serial interface data pin

- Driver interface OUT1 O Driver output (to Actuator) OUT2 O Driver output (to Actuator)
- Power supply nin

•	rower	suppry	/ pm
	VDD	Р	Power Supply
	VCC	р	CNID

- VSS
 - Р GND

*Process when pins are not used

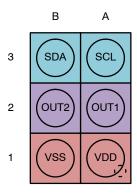
PIN TYPE "O" – Ensure that it is set to OPEN. PIN TYPE "I" – OPEN is inhibited. Ensure that it is connected to the VDD or VSS even when it is unused. (Please contact ON Semiconductor for more information about selection of VDD or VSS.) PIN TYPE "B" – If you are unsure about processing method on the pin description of pin layout table, please contact us.

Note that incorrect processing of unused pins may result in defects.

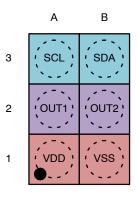
PIN LAYOUT

Table 2. PIN LAYOUT

Circuit Name	Number of PINs
Driver	2
Power	2
Logic	2



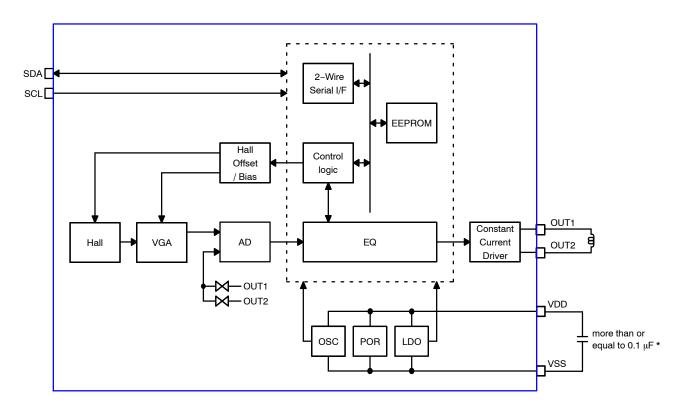
BOTTOM VIEW



TOP VIEW



BLOCK DIAGRAM



*Consider capacitance of capacitor between VDD and VSS. According to power source environment, attach an additional capacitor in camera module.

Figure 2. Block Diagram

HALL ELEMENT POSITION

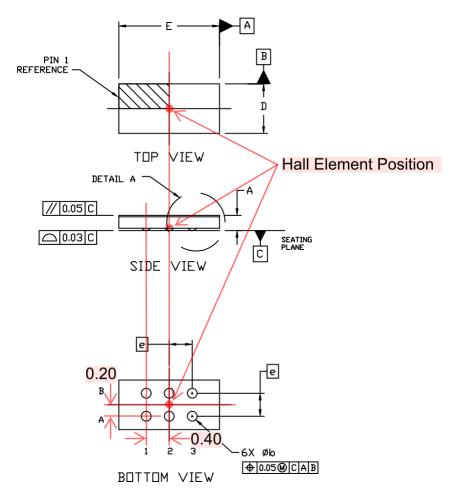


Figure 3. Hall Element Position

ELECTRICAL CHARACTERISTICS

Table 3. ABSOLUTE MAXIMUM RATINGS (VSS = 0 V)

Symbol	Item	Condition	Rating	Unit
V _{DD} 33 max	Supply voltage	Ta ≤ 25°C	-0.3~4.6	V
V _I 33,V _O 33	Input/output voltage	Ta≤25°C	-0.3~V _{DD} 33 + 0.3	V
Tstg	Storage ambient temperature		-55~125	°C
Topr	Operating ambient temperature		-30~70	°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

Table 4. ACCEPTABLE OPERATION RANGE (Ta = -30~70°C, VSS = 0 V, 3 V power supply (VDD))

Symbol	Item	Min	Тур	Max	Unit
V _{DD} 33	Supply voltage	2.6	2.8	3.3	V
V _{IN}	Input voltage range	0	_	V _{DD} 33	V

Table 5. DC CHARACTERISTICS (Input / output level at VSS = 0 V, VDD = 2.6 V~3.3V, Ta = -30~70°C)

Symbol	Item	Condition	Min	Тур	Max	Unit	Applicable Pins
VIH	High-level input voltage	CMOS compliant schmitt	1.4	-	-	V	SCL, SDA
VIL	Low-level input voltage		-	-	0.4	V	
VOL	Low-level output voltage	IOL = 2 mA	-	-	0.2	V	SDA

Table 6. DRIVER OUTPUT (OUT1, OUT2) (VSS = 0 V, VDD = 2.8 V, Ta = 25°C)

Symbol	ltem	Condition	Min	Тур	Max	Unit	Applicable Pins
lfull	Maximum current		142.5	150	157.5	mA	OUT1, OUT2

Table 7. NON-VOLATILE MEMORY CHARACTERISTICS

Symbol	Item	Condition	Min	Тур	Max	Unit	Applicable Circuit
EN	Endurance		-	-	1000	Cycles	EEPROM
RT	Data retention		10	-	-	Years	
tWT	Write time		-	-	20	ms	

AC CHARACTERISTICS

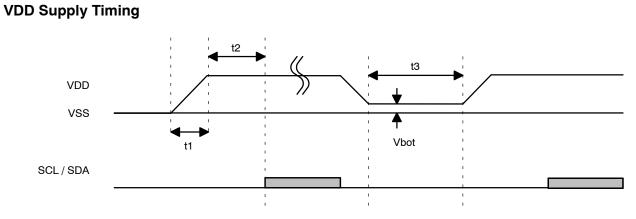


Figure 4. VDD Supply Timing

It is available to use 2-wire serial interface 5ms later for Power On Reset of VDD.

Table 8. VDD SUPPLY TIMING

Symbol	Item	Min	Тур	Max	Unit
t1	VDD turn on time	-	-	3	ms
t2	2-wire serial interface start time from VDD on	5	-	-	ms
t3	VDD off time	100	-	-	ms
Vbot	Bottom Voltage	-	-	0.1	V

AC Specification

Figure 5 shows interface timing definition and Table 9 shows electric characteristics.

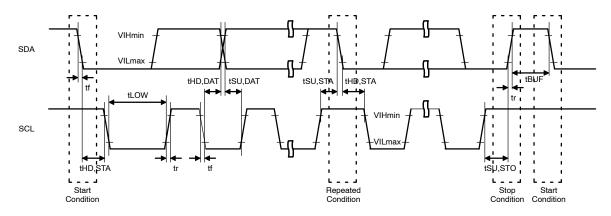


Figure 5. 2-wire Serial Interface Timing Definition

Symbol	Item	Pin Name	Fast-mode			Fast-mode Plus			
			Min	Тур	Max	Min	Тур	Max	Unit
FSCL	SCL clock frequency	SCL	-	-	400	-	-	1000	kHz
tHD,STA	START condition hold time	SCL SDA	0.6	-	_	0.26	-	-	μs
tLOW	SCL clock Low period	SCL	1.3	-	-	0.5	-	-	μs
tHIGH	SCL clock High period	SCL	0.6	-	-	0.26	-	-	μs
tSU,STA	Setup time for repetition START condition	SCL SDA	0.6	-	_	0.26	-	-	μs
tHD,DAT	Data hold time	SCL SDA	0 (Note 1)	-	0.9	0 (Note 1)	-	-	μs
tSU,DAT	Data setup time	SCL SDA	100	-	_	50	-	-	ns
tr	SDA, SCL rising time	SCL SDA	-	-	300	-	-	120	ns
tf	SDA, SCL falling time	SCL SDA	-	-	300	-	-	120	ns
tSU,STO	STOP condition setup time	SCL SDA	0.6	-	_	0.26	-	-	μs
tBUF	Bus free time between STOP and START	SCL SDA	1.3	_	-	0.5	-	-	μs

Table 9. ELECTRICAL CHARACTERISTICS FOR 2-WIRE SERIAL INTERFACE (AC CHARACTERISTICS)

1. This LSI is designed for a condition with typ. 20 ns of hold time. If SDA signal is unstable around falling point of SCL signal, please implement an appropriate treatment on board, such as inserting a resistor.

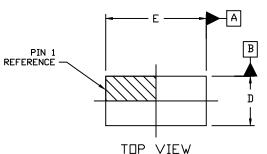
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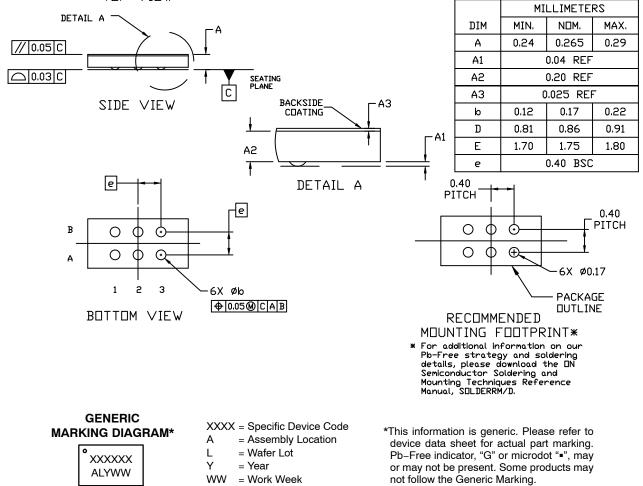
ISSUE O

DATE 23 OCT 2018



NDTES:

- 1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
- 2. CONTROLLING DIMENSION: MILLIMETERS
- 3. DATUM C, THE SEATING PLANE, IS DEFINED BY THE SPERICAL CROWNS OF THE CONTACT BALLS.
- 4. COPLANARITY APPLIES TO THE SPHERICAL CROWNS OF THE CONTACT BALLS.
- 5. DIMENSION 6 IS MEASURED AT THE MAXIMUM CONTACT BALL DIAMETER PARALLEL TO DATUM C.



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